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Edition 3.0 2022-04  
COMMENTED VERSION

# INTERNATIONAL STANDARD



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**Electrostatics –  
Part 5-3: Protection of electronic devices from electrostatic phenomena –  
Properties and requirements classification for packaging intended for  
electrostatic discharge sensitive devices**

INTERNATIONAL  
ELECTROTECHNICAL  
COMMISSION

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## CONTENTS

FOREWORD .....	4
INTRODUCTION .....	6
1    Scope .....	7
2    Normative references .....	7
3    Terms, definitions and abbreviated terms.....	7
3.1    Terms and definitions .....	7
3.2    Abbreviated terms .....	9
4    Tailoring .....	9
5    Packaging application requirement .....	9
5.1    General.....	9
5.2    Inside an EPA .....	9
5.3    Outside an EPA.....	10
6    Classification of ESD packaging material properties .....	10
6.1    General.....	10
6.2    Material resistance properties .....	10
6.2.1    General.....	10
6.2.2    Resistance of conductive materials .....	10
6.2.3    Resistance of electrostatic field shielding materials .....	10
6.2.3    Resistance of dissipative materials .....	11
6.2.4    Resistance of insulating materials .....	11
6.3    Material electrostatic shielding properties.....	11
6.3.1    Electrostatic discharge shielding .....	11
6.3.2    Electrostatic field shielding .....	11
7    Technical requirements for ESD protective packaging .....	11
7.1    Packaging and material properties .....	11
7.2    Packaging marking .....	13
7.2.1    Classification symbol.....	13
7.2.2    Packaging classification.....	13
7.2.3    Traceability .....	14
Annex A (informative) Guidance on ESD packaging material <del>guidance</del> .....	15
A.1    Environment and device sensitivity.....	15
A.1.1    General.....	15
A.1.2    Environment.....	15
A.1.3    Device sensitivity.....	16
A.2    Equipotential bonding .....	17
A.3    Dissipative material for intimate contact .....	17
A.4    Packaging from incoming material to the point of use.....	17
A.5    Periodic verification .....	18
A.6    Examples of measurement procedures for qualification and verification of packaging.....	19
Annex B (informative) Device damage .....	21
B.1    Damage from ESD.....	21
B.2    Discharge to a device .....	21
B.2.1    Human body model (HBM) [2] and isolated conductors Discharge to device from external objects .....	21
B.2.2    Retained charge on a packaging .....	21

This is a preview of "IEC 61340-5-3 Ed. 3....". Click here to purchase the full version from the ANSI store.

B.3	Discharge from a floating device (CDM) .....	21
B.3.1	<del>Charged device model (CDM)</del> Discharges from devices in an electric field....	21
B.3.2	<del>Triboelectrification</del> Discharges from tribo-electrified devices .....	21
Annex C (informative)	Guidance on electric field shielding.....	22
Annex D (informative)	Low charging material property.....	23
Bibliography.....		24
List of comments.....		25
Figure 1 – Example of packaging label (*Primary function code) .....	13	
Figure A.1 – Examples of EPA configurations .....	16	
Figure A.2 – Application of ESD protective packaging .....	18	
Table 1 – Test methods for electrostatic protective packaging .....	12	
Table 2 – Test methods and requirements for electrostatic discharge shielding packaging .....	13	
Table 3 – Primary function code <del>f</del> and ESD classification symbol.....	14	
Table A.1 – Packaging characteristics for environmental consideration .....	15	
Table A.2 – Examples of qualification and verification of packaging .....	19	

## INTERNATIONAL ELECTROTECHNICAL COMMISSION

### ELECTROSTATICS –

#### Part 5-3: Protection of electronic devices from electrostatic phenomena – Properties and requirements classification for packaging intended for electrostatic discharge sensitive devices

#### FOREWORD

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
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**This commented version (CMV) of the official standard IEC 61340-5-3:2022 edition 3.0 allows the user to identify the changes made to the previous IEC 61340-5-3:2015 edition 2.0. Furthermore, comments from IEC TC 101 experts are provided to explain the reasons of the most relevant changes.**

**A vertical bar appears in the margin wherever a change has been made. Additions are in green text, deletions are in strikethrough red text. Experts' comments are identified by a blue-background number. Mouse over a number to display a pop-up note with the comment.**

**This publication contains the CMV and the official standard. The full list of comments is available at the end of the CMV.**

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IEC 61340-5-3 has been prepared by IEC technical committee 101: Electrostatics. It is an International Standard.

This third edition cancels and replaces the second edition published in 2015. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) reference to IEC 61340-4-10<sup>1</sup> [1]<sup>2</sup> was removed;
- b) material resistance property "electrostatic field shielding" was removed;
- c) the requirement for electrostatic discharge shielding was changed from 50 nJ to 20 nJ;
- d) Table 1 – footnote "b" was changed to mention the two-point probe in IEC 61340-2-3;
- e) "shall be marked" was changed to "should be marked" in 7.2.2 and 7.2.3;
- f) Table 3 – the classification symbol and the primary function code F was removed;
- g) Table A.2 – references to IEC TS 61340-5-4 [2] and IEC TR 61340-5-5 [3] were added;
- h) Annex C – guidance regarding electric field shielding was added;
- i) Annex D – low charging material property was added.

The text of this International Standard is based on the following documents:

Draft	Report on voting
101/649/FDIS	101/660/RVD

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at [www.iec.ch/members\\_experts/refdocs](http://www.iec.ch/members_experts/refdocs). The main document types developed by IEC are described in greater detail at [www.iec.ch/standardsdev/publications](http://www.iec.ch/standardsdev/publications).

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**IMPORTANT – The 'colour inside' logo on the cover page of this publication indicates that it contains colours which are considered to be useful for the correct understanding of its contents. Users should therefore print this document using a colour printer.**

<sup>1</sup> Withdrawn.

<sup>2</sup> Numbers in square brackets refer to the bibliography.

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## INTRODUCTION

Packaging is necessary to protect electrostatic discharge sensitive devices (ESDSS) from static electricity and electrostatic discharge (ESD) damage as well as 1 physical and environmental damage during manufacture, transportation and storage.

## ELECTROSTATICS –

### Part 5-3: Protection of electronic devices from electrostatic phenomena – Properties and requirements classification for packaging intended for electrostatic discharge sensitive devices

#### 1 Scope

This part of IEC 61340 defines the ESD protective packaging properties ~~needed~~ required to protect ~~electrostatic discharge~~ ESD sensitive devices (ESDSs) through all phases of production, rework ~~and~~ and maintenance, transport and storage. Test methods are referenced to evaluate packaging and packaging materials for these product and material properties. Performance limits are provided.

This document does not address protection from electromagnetic interference (EMI), electromagnetic pulsing (EMP) or protection of ~~volatile materials~~ electrically initiated explosive materials or devices <sup>2</sup>.

#### 2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 61340-2-3, *Electrostatics – Part 2-3: Methods of test for determining the resistance and resistivity of solid-~~planar~~ materials used to avoid electrostatic charge accumulation*

IEC 61340-4-8, *Electrostatics – Part 4-8: Standard test methods for specific applications – Electrostatic discharge shielding – Bags*

~~IEC 61340-4-10, Electrostatics – Part 4-10: Standard test methods for specific applications – Two point resistance measurement<sup>3</sup>~~ <sup>3</sup>

~~IEC 60417, Graphical symbols for use on equipment (available at <http://www.graphical-symbols.info/equipment>)~~ <sup>4</sup>



# INTERNATIONAL STANDARD

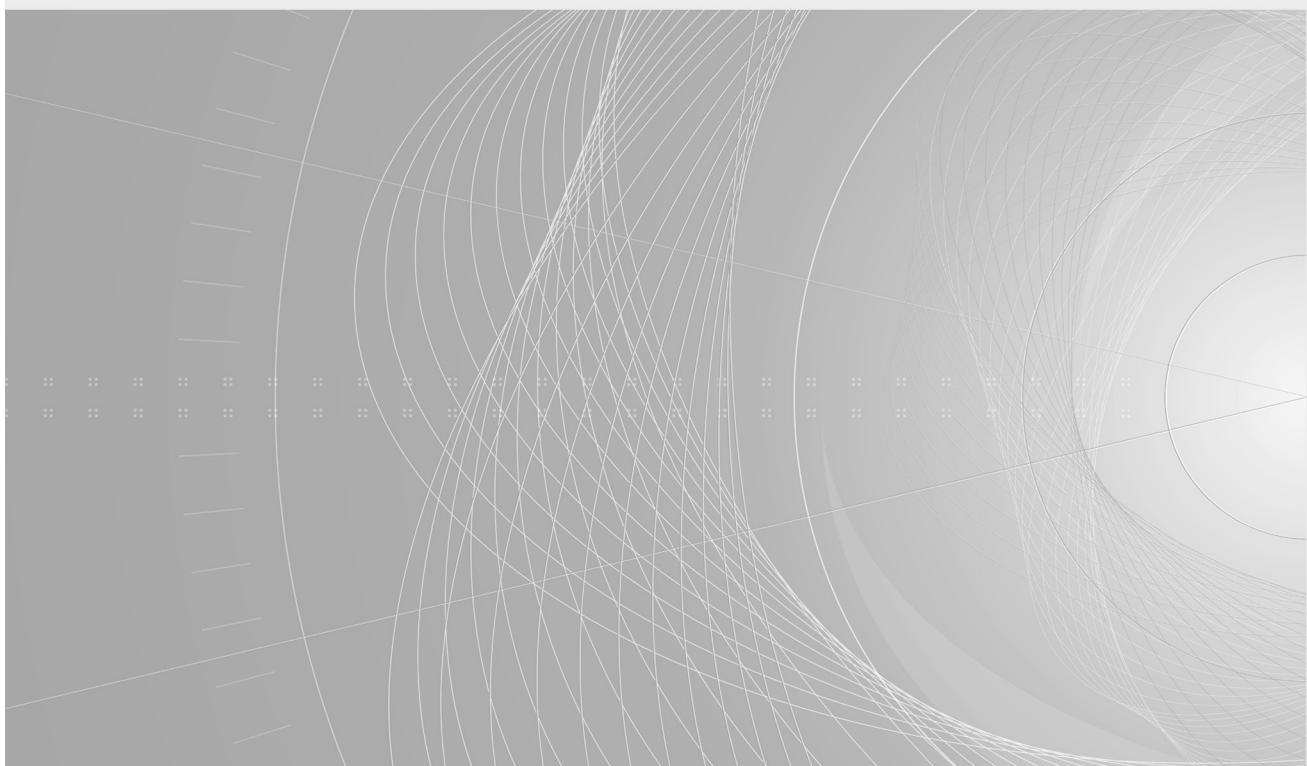
## NORME INTERNATIONALE

**Electrostatics –**

**Part 5-3: Protection of electronic devices from electrostatic phenomena –  
Properties and requirements classification for packaging intended for  
electrostatic discharge sensitive devices**

**Électrostatique –**

**Partie 5-3: Protection des dispositifs électroniques contre les phénomènes  
électrostatiques – Classification des propriétés et des exigences relatives à  
l'emballage destiné aux dispositifs sensibles aux décharges électrostatiques**



## CONTENTS

FOREWORD .....	4
INTRODUCTION .....	6
1    Scope .....	7
2    Normative references .....	7
3    Terms, definitions and abbreviated terms .....	7
3.1    Terms and definitions.....	7
3.2    Abbreviated terms.....	9
4    Tailoring .....	9
5    Packaging application requirement .....	9
5.1    General.....	9
5.2    Inside an EPA .....	9
5.3    Outside an EPA .....	9
6    Classification of ESD packaging material properties .....	10
6.1    General.....	10
6.2    Material resistance properties .....	10
6.2.1    General .....	10
6.2.2    Resistance of conductive materials .....	10
6.2.3    Resistance of dissipative materials .....	10
6.2.4    Resistance of insulating materials.....	11
6.3    Material electrostatic shielding properties .....	11
6.3.1    Electrostatic discharge shielding.....	11
6.3.2    Electrostatic field shielding .....	11
7    Technical requirements for ESD protective packaging .....	11
7.1    Packaging and material properties .....	11
7.2    Packaging marking .....	12
7.2.1    Classification symbol .....	12
7.2.2    Packaging classification.....	13
7.2.3    Traceability.....	13
Annex A (informative) Guidance on ESD packaging material .....	14
A.1    Environment and device sensitivity .....	14
A.1.1    General .....	14
A.1.2    Environment .....	14
A.1.3    Device sensitivity .....	15
A.2    Equipotential bonding .....	16
A.3    Dissipative material for intimate contact .....	16
A.4    Packaging from incoming material to the point of use.....	16
A.5    Periodic verification .....	17
A.6    Examples of measurement procedures for qualification and verification of packaging .....	18
Annex B (informative) Device damage .....	20
B.1    Damage from ESD .....	20
B.2    Discharge to a device .....	20
B.2.1    Discharge to device from external objects.....	20
B.2.2    Retained charge on a packaging.....	20
B.3    Discharge from a floating device (CDM).....	20

This is a preview of "IEC 61340-5-3 Ed. 3....". Click here to purchase the full version from the ANSI store.

B.3.1	Discharges from devices in an electric field .....	20
B.3.2	Discharges from tribo-electrified devices .....	20
Annex C (informative)	Guidance on electric field shielding .....	21
Annex D (informative)	Low charging material property .....	22
Bibliography.....		23
Figure 1 – Example of packaging label (*Primary function code) .....	13	
Figure A.1 – Examples of EPA configurations .....	15	
Figure A.2 – Application of ESD protective packaging.....	17	
Table 1 – Test methods for electrostatic protective packaging .....	12	
Table 2 – Test methods and requirements for electrostatic discharge shielding packaging .....	12	
Table 3 – Primary function code and ESD classification symbol .....	13	
Table A.1 – Packaging characteristics for environmental consideration.....	14	
Table A.2 – Examples of qualification and verification of packaging .....	18	

## INTERNATIONAL ELECTROTECHNICAL COMMISSION

### ELECTROSTATICS –

#### **Part 5-3: Protection of electronic devices from electrostatic phenomena – Properties and requirements classification for packaging intended for electrostatic discharge sensitive devices**

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## ELECTROSTATICS –

### **Part 5-3: Protection of electronic devices from electrostatic phenomena – Properties and requirements classification for packaging intended for electrostatic discharge sensitive devices**

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IEC 61340-4-8, *Electrostatics – Part 4-8: Standard test methods for specific applications – Electrostatic discharge shielding – Bags*

## SOMMAIRE

AVANT-PROPOS .....	26
INTRODUCTION .....	28
1    Domaine d'application .....	29
2    Références normatives .....	29
3    Termes, définitions et abréviations .....	29
3.1    Termes et définitions .....	29
3.2    Abréviations .....	31
4    Personnalisation .....	31
5    Exigence relative à l'application des emballages .....	31
5.1    Généralités .....	31
5.2    A l'intérieur d'une EPA .....	31
5.3    A l'extérieur d'une EPA .....	32
6    Classification des propriétés des matériaux d'emballage contre les DES .....	32
6.1    Généralités .....	32
6.2    Propriétés de résistance des matériaux .....	32
6.2.1    Généralités .....	32
6.2.2    Résistance des matériaux conducteurs .....	32
6.2.3    Résistance des matériaux dissipatifs .....	33
6.2.4    Résistance des matériaux isolants .....	33
6.3    Propriétés de blindage électrostatique des matériaux .....	33
6.3.1    Blindage contre les décharges électrostatiques .....	33
6.3.2    Blindage contre les champs électrostatiques .....	33
7    Exigences techniques pour les emballages de protection contre les DES .....	33
7.1    Propriétés de l'emballage et des matériaux .....	33
7.2    Marquage de l'emballage .....	35
7.2.1    Symbole de classification .....	35
7.2.2    Classification de l'emballage .....	35
7.2.3    Traçabilité .....	36
Annex A (informative) Recommandations relatives aux matériaux d'emballage contre les DES .....	37
A.1    Environnement et sensibilité du dispositif .....	37
A.1.1    Généralités .....	37
A.1.2    Environnement .....	37
A.1.3    Sensibilité du dispositif .....	38
A.2    Liaison équipotentielle .....	38
A.3    Matériau dissipatif utilisé pour le contact direct .....	39
A.4    Emballage depuis l'arrivée des ESDS jusqu'à leur point d'utilisation .....	39
A.5    Vérification périodique .....	40
A.6    Exemples de procédures de mesurage pour la qualification et la vérification des emballages .....	41
Annex B (informative) Dommages subis par les dispositifs .....	43
B.1    Dommages liés aux DES .....	43
B.2    Décharge subie par un dispositif .....	43
B.2.1    Décharge subie par un dispositif et causée par des objets externes .....	43
B.2.2    Charge conservée sur un emballage .....	43
B.3    Décharges issues d'un dispositif flottant (CDM) .....	43

This is a preview of "IEC 61340-5-3 Ed. 3....". Click here to purchase the full version from the ANSI store.

B.3.1	Décharges issues de dispositifs situés dans un champ électrique.....	43
B.3.2	Décharges issues de dispositifs triboélectriques .....	43
Annex C (informative)	Recommandations relatives au blindage contre les champs électriques .....	45
Annex D (informative)	Propriété des matériaux à faible charge .....	46
Bibliographie.....		47
Figure 1 – Exemple d'étiquette d'emballage (*code de fonction primaire) .....	35	
Figure A.1 – Exemples de configurations d'EPA.....	38	
Figure A.2 – Application des emballages de protection contre les DES .....	40	
Tableau 1 – Méthodes d'essai pour les emballages de protection electrostatique .....	34	
Tableau 2 – Méthodes et exigences d'essai relatives aux emballages pour le blindage contre les décharges électrostatiques .....	35	
Tableau 3 – Code de fonction primaire/symbole de classification DES .....	36	
Tableau A.1 – Caractéristiques de l'emballage du point de vue environnemental .....	37	
Tableau A.2 – Exemples pour la qualification et la vérification des emballages .....	41	

## COMMISSION ÉLECTROTECHNIQUE INTERNATIONALE

### ÉLECTROSTATIQUE –

#### **Partie 5-3: Protection des dispositifs électroniques contre les phénomènes électrostatiques – Classification des propriétés et des exigences relatives à l'emballage destiné aux dispositifs sensibles aux décharges électrostatiques**

### AVANT-PROPOS

- 1) La Commission Electrotechnique Internationale (IEC) est une organisation mondiale de normalisation composée de l'ensemble des comités électrotechniques nationaux (Comités nationaux de l'IEC). L'IEC a pour objet de favoriser la coopération internationale pour toutes les questions de normalisation dans les domaines de l'électricité et de l'électronique. A cet effet, l'IEC – entre autres activités – publie des Normes internationales, des Spécifications techniques, des Rapports techniques, des Spécifications accessibles au public (PAS) et des Guides (ci-après dénommés "Publication(s) de l'IEC"). Leur élaboration est confiée à des comités d'études, aux travaux desquels tout Comité national intéressé par le sujet traité peut participer. Les organisations internationales, gouvernementales et non gouvernementales, en liaison avec l'IEC, participent également aux travaux. L'IEC collabore étroitement avec l'Organisation Internationale de Normalisation (ISO), selon des conditions fixées par accord entre les deux organisations.
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La Norme internationale IEC 61340-5-3 a été établie par le comité d'études 101 de l'IEC: Electrostatique. Il s'agit d'une Norme internationale.

Cette troisième édition annule et remplace la deuxième édition parue en 2015. Cette édition constitue une révision technique.

This is a preview of "IEC 61340-5-3 Ed. 3....". Click here to purchase the full version from the ANSI store.

Cette édition inclut les modifications techniques majeures suivantes par rapport à l'édition précédente:

- a) la référence à l'IEC 61340-4-10<sup>1</sup> [1]<sup>2</sup> a été supprimée;
- b) la propriété de résistance des matériaux "blindage contre les champs électrostatiques" a été supprimée;
- c) l'exigence relative au blindage contre les décharges électrostatiques qui était de 50 nJ est désormais fixée à 20 nJ;
- d) la note b) du Tableau 1 a été modifiée de manière à mentionner la sonde à deux points de l'IEC 61340-2-3;
- e) les expressions "doit figurer" et "doivent figurer" ont été remplacées par l'expression "il convient d'apposer" en 7.2.2 et en 7.2.3;
- f) dans le Tableau 3, le symbole de classification et le code de fonction primaire F ont été supprimés;
- g) dans le Tableau A.2, des références à l'IEC TS 61340-5-4 [2] et à l'IEC TR 61340-5-5 [3] ont été ajoutées;
- h) l'Annex C, Recommandations relatives au blindage contre les champs électriques, a été ajoutée;
- i) l'Annex D, Propriété des matériaux à faible charge, a été ajoutée.

Le texte de cette Norme internationale est issu des documents suivants:

Projet	Rapport de vote
101/649/FDIS	101/660/RVD

Le rapport de vote indiqué dans le tableau ci-dessus donne toute information sur le vote ayant abouti à son approbation.

La langue employée pour l'élaboration de cette Norme internationale est l'anglais.

Le présent document a été rédigé selon les Directives ISO/IEC, Partie 2, il a été développé selon les Directives ISO/IEC, Partie 1 et les Directives ISO/IEC, Supplément IEC, disponibles sous [www.iec.ch/members\\_experts/refdocs](http://www.iec.ch/members_experts/refdocs). Les principaux types de documents développés par l'IEC sont décrits plus en détail sous [www.iec.ch/standardsdev/publications](http://www.iec.ch/standardsdev/publications).

Une liste de toutes les parties de la série IEC 61340, publiées sous le titre général *Electrostatique*, se trouve sur le site web de l'IEC.

Le comité a décidé que le contenu du présent document ne sera pas modifié avant la date de stabilité indiquée sur le site web de l'IEC sous [webstore.iec.ch](http://webstore.iec.ch) dans les données relatives au document recherché. A cette date, le document sera

- reconduit,
- supprimé,
- remplacé par une édition révisée, ou
- amendé.

<sup>1</sup> Supprimée.

<sup>2</sup> Les chiffres entre crochets renvoient à la Bibliographie.

This is a preview of "IEC 61340-5-3 Ed. 3....". Click here to purchase the full version from the ANSI store.

## INTRODUCTION

L'emballage est nécessaire pour protéger les dispositifs sensibles aux décharges électrostatiques (ESDS, *Electrostatic Discharge Sensitive Device*) contre les dommages liés à l'électricité statique et aux décharges électrostatiques (DES), et contre les dommages physiques et environnementaux au cours de la fabrication, du transport et du stockage.

## ÉLECTROSTATIQUE –

### Partie 5-3: Protection des dispositifs électroniques contre les phénomènes électrostatiques – Classification des propriétés et des exigences relatives à l'emballage destiné aux dispositifs sensibles aux décharges électrostatiques

#### 1 Domaine d'application

La présente partie de l'IEC 61340 définit les propriétés des emballages de protection contre les DES qui sont exigées pour protéger les dispositifs sensibles aux DES (ESDS) pendant toutes les phases de production, de retouche et maintenance, de transport et de stockage. Des méthodes d'essai sont citées pour évaluer les emballages et les matériaux d'emballage par rapport aux propriétés de ces produits et matériaux. Des limites de performance sont données.

Le présent document ne traite pas de la protection contre le brouillage électromagnétique (EMI, *Electromagnetic Interference*) et les impulsions électromagnétiques (EMP, *Electromagnetic Pulsing*) ni de la protection des matériaux ou dispositifs explosifs à amorçage électrique.

#### 2 Références normatives

Les documents suivants sont cités dans le texte de sorte qu'ils constituent, pour tout ou partie de leur contenu, des exigences du présent document. Pour les références datées, seule l'édition citée s'applique. Pour les références non datées, la dernière édition du document de référence s'applique (y compris les éventuels amendements).

IEC 61340-2-3, *Electrostatique – Partie 2-3: Méthodes d'essais pour la détermination de la résistance et de la résistivité des matériaux solides destinés à éviter les charges électrostatiques*

IEC 61340-4-8, *Electrostatique – Partie 4-8: Méthodes d'essai normalisées pour des applications spécifiques – Blindage contre les décharges électrostatiques – Sacs*